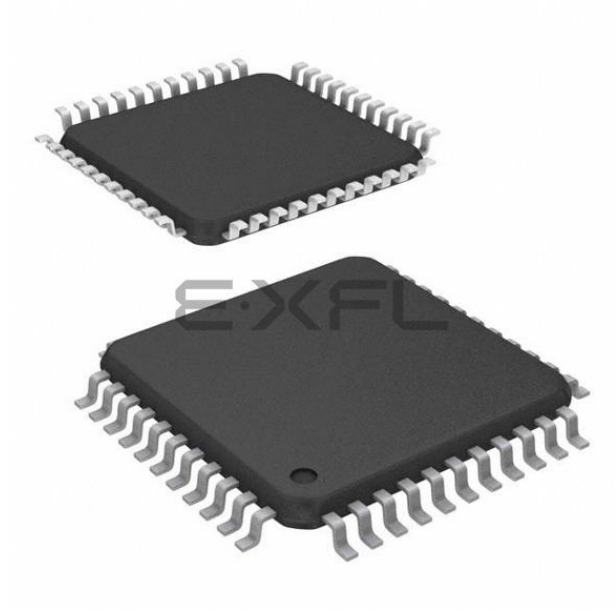

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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	AVR
Core Size	8-Bit
Speed	20MHz
Connectivity	I²C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	32
Program Memory Size	32KB (16K x 16)
Program Memory Type	FLASH
EEPROM Size	1K x 8
RAM Size	2K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 5.5V
Data Converters	A/D 8x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	44-TQFP
Supplier Device Package	44-TQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/atmega324pa-aur

- Programmable Watchdog Timer with Separate On-chip Oscillator
- On-chip Analog Comparator
- Interrupt and Wake-up on Pin Change

- Special Microcontroller Features
  - Power-on Reset and Programmable Brown-out Detection
  - Internal Calibrated RC Oscillator
  - External and Internal Interrupt Sources
  - Six Sleep Modes: Idle, ADC Noise Reduction, Power-save, Power-down, Standby and Extended Standby
- I/O and Packages
  - 32 Programmable I/O Lines
  - 40-pin PDIP, 44-lead TQFP, 44-pad VQFN/QFN/MLF
  - 44-pad DRQFN

– 49-ball VFBGA

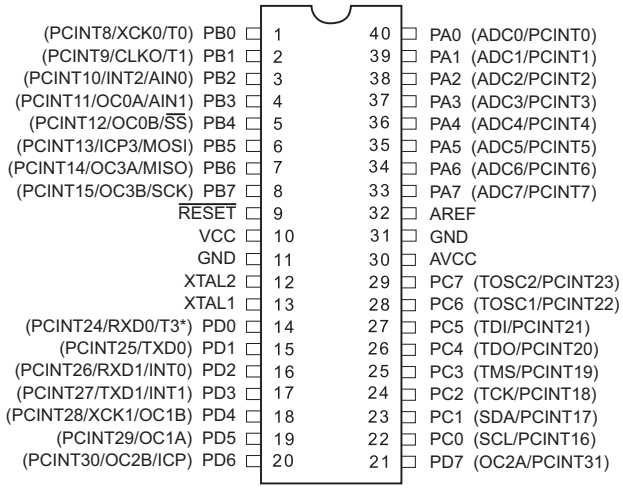
- Operating Voltages
  - 1.8 - 5.5V
- Speed Grades
  - 0 - 4MHz @ 1.8 - 5.5V
  - 0 - 10MHz @ 2.7 - 5.5V
  - 0 - 20MHz @ 4.5 - 5.5V
- Power Consumption at 1MHz, 1.8V, 25°C
  - Active: 0.4mA
  - Power-down Mode: 0.1µA
  - Power-save Mode: 0.6µA (Including 32kHz RTC)

Note: 1. See ”Data retention” on page 9 for details.

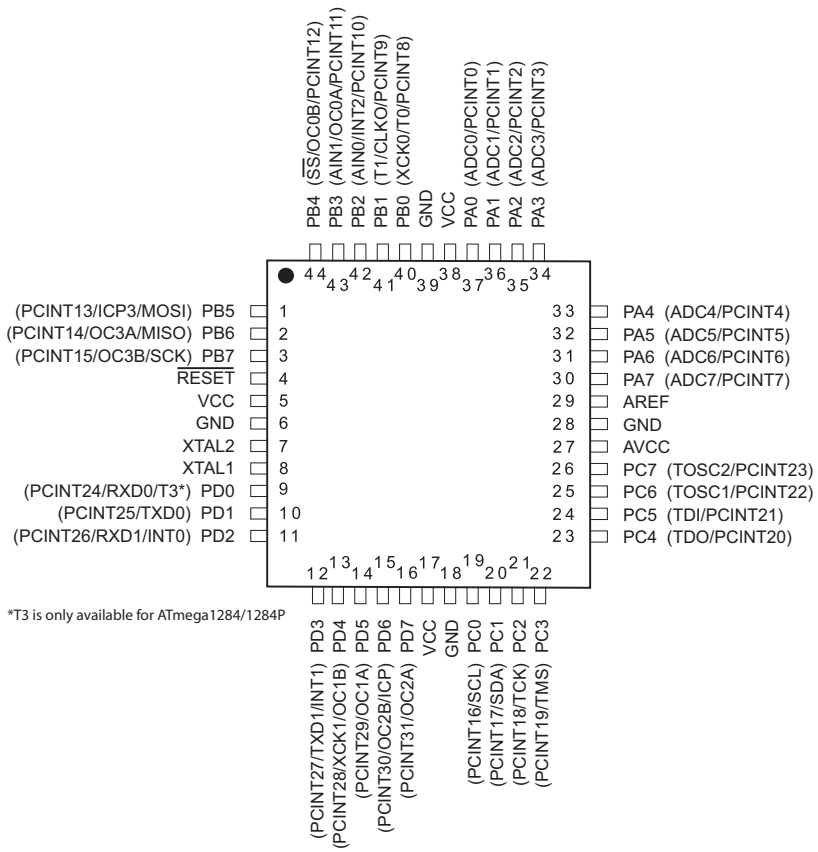
1. Pin configurations

1.1 Pinout - PDIP/TQFP/VQFN/QFN/MLF for ATmega164A/164PA/324A/324PA/644A/644PA/1284/1284P

Figure 1-1. Pinout.



TQFP/QFN/MLF



Note: The large center pad underneath the VQFN/QFN/MLF package should be soldered to ground on the board to ensure good mechanical stability.

1.2 Pinout - DRQFN for Atmel ATmega164A/164PA/324A/324PA

Figure 1-2. DRQFN - pinout.

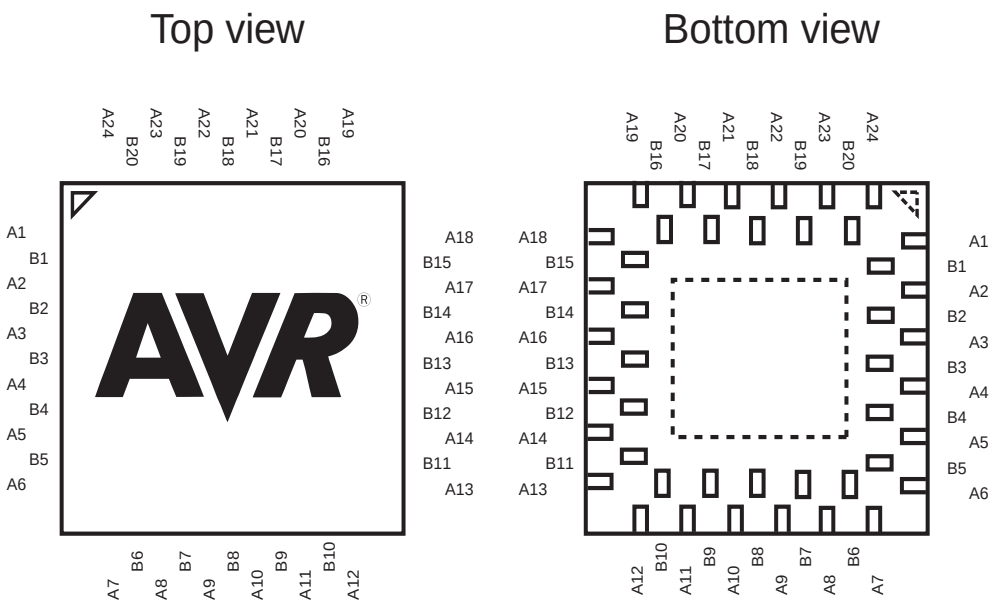


Table 1-1. DRQFN - pinout.

A1	PB5	**A7**	PD3	**A13**	PC4	**A19**	PA3
B1	PB6	**B6**	PD4	**B11**	PC5	**B16**	PA2
A2	PB7	**A8**	PD5	**A14**	PC6	**A20**	PA1
B2	$\overline{\text{RESET}}$	**B7**	PD6	**B12**	PC7	**B17**	PA0
A3	VCC	**A9**	PD7	**A15**	AVCC	**A21**	VCC
B3	GND	**B8**	VCC	**B13**	GND	**B18**	GND
A4	XTAL2	**A10**	GND	**A16**	AREF	**A22**	PB0
B4	XTAL1	**B9**	PC0	**B14**	PA7	**B19**	PB1
A5	PD0	**A11**	PC1	**A17**	PA6	**A23**	PB2
B5	PD1	**B10**	PC2	**B15**	PA5	**B20**	PB3
A6	PD2	**A12**	PC3	**A18**	PA4	**A24**	PB4

1.3 Pinout - VFBGA for Atmel ATmega164A/164PA/324A/324PA

Figure 1-3. VFBGA - pinout.

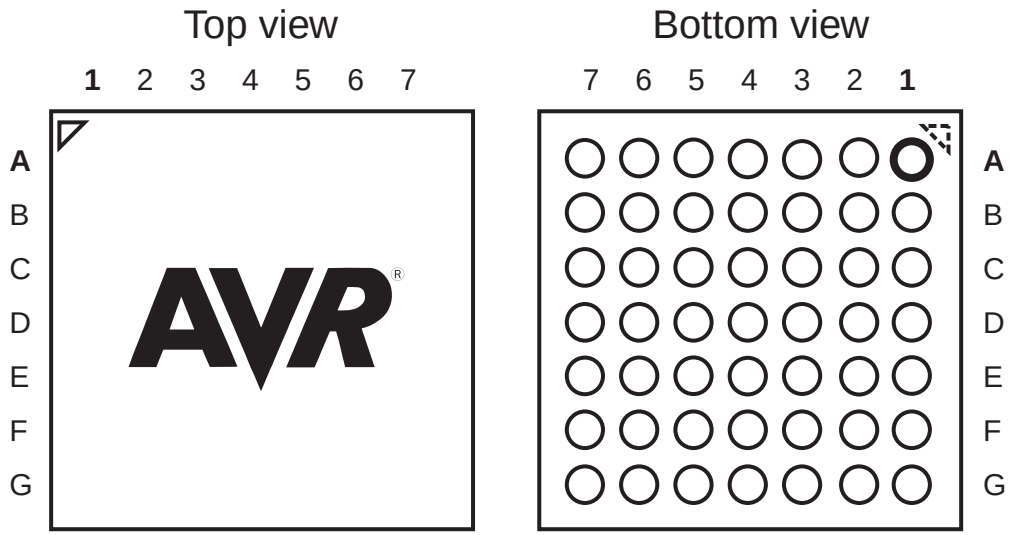


Table 1-2. BGA - pinout.

	GND	PB4	PB2	GND	VCC	PA2	GND
	PB6	PB5	PB3	PB0	PA0	PA3	PA5
	VCC	RESET	PB7	PB1	PA1	PA6	AREF
	GND	XTAL2	PD0	GND	PA4	PA7	GND
	XTAL1	PD1	PD5	PD7	PC5	PC7	AVCC
	PD2	PD3	PD6	PC0	PC2	PC4	PC6
	GND	PD4	VCC	GND	PC1	PC3	GND

2. Overview

The Atmel ATmega164A/164PA/324A/324PA/644A/644PA/1284/1284P is a low-power CMOS 8-bit microcontroller based on the AVR enhanced RISC architecture. By executing powerful instructions in a single clock cycle, the ATmega164A/164PA/324A/324PA/644A/644PA/1284/1284P achieves throughputs approaching 1 MIPS per MHz allowing the system designer to optimize power consumption versus processing speed.

timer base while the rest of the device is sleeping. The ADC Noise Reduction mode stops the CPU and all I/O modules except Asynchronous Timer and ADC, to minimize switching noise during ADC conversions. In Standby mode, the Crystal/Resonator Oscillator is running while the rest of the device is sleeping. This allows very fast start-up combined with low power consumption. In Extended Standby mode, both the main Oscillator and the Asynchronous Timer continue to run.

Atmel offers the QTouch® library for embedding capacitive touch buttons, sliders and wheels functionality into AVR microcontrollers. The patented charge-transfer signal acquisition offers robust sensing and includes fully debounced reporting of touch keys and includes Adjacent Key Suppression® (AKS™) technology for unambiguous detection of key events. The easy-to-use QTouch Suite toolchain allows you to explore, develop and debug your own touch applications.

The device is manufactured using Atmel's high-density nonvolatile memory technology. The On-chip ISP Flash allows the program memory to be reprogrammed in-system through an SPI serial interface, by a conventional nonvolatile memory programmer, or by an On-chip Boot program running on the AVR core. The boot program can use any interface to download the application program in the application Flash memory. Software in the Boot Flash section will continue to run while the Application Flash section is updated, providing true Read-While-Write operation. By combining an 8-bit RISC CPU with In-System Self-Programmable Flash on a monolithic chip, the Atmel ATmega164A/164PA/324A/324PA/644A/644PA/1284/1284P is a powerful microcontroller that provides a highly flexible and cost effective solution to many embedded control applications.

The ATmega164A/164PA/324A/324PA/644A/644PA/1284/1284P is supported with a full suite of program and system development tools including: C compilers, macro assemblers, program debugger/simulators, in-circuit emulators, and evaluation kits.

2.2 Comparison between ATmega164A, ATmega164PA, ATmega324A, ATmega324PA, ATmega644A, ATmega644PA, ATmega1284 and ATmega1284P

Table 2-1. Differences between ATmega164A, ATmega164PA, ATmega324A, ATmega324PA, ATmega644A, ATmega644PA, ATmega1284 and ATmega1284P.

Device	Flash	EEPROM	RAM	Units
ATmega164A	16K	512	1K	bytes
ATmega164PA	16K	512	1K	
ATmega324A	32K	1K	2K	
ATmega324PA	32K	1K	2K	
ATmega644A	64K	2K	4K	
ATmega644PA	64K	2K	4K	
ATmega1284	128K	4K	16K	
ATmega1284P	128K	4K	16K	

2.3 Pin Descriptions11

2.3.1 VC

Digital supply voltage.

2.3.2 GND

Ground.

2.3.3 Port A (PA7:PA0)

Port A serves as analog inputs to the Analog-to-digital Converter.
Port A also serves as an 8-bit bi-directional I/O port with internal pull-up resistors (selected for each bit). The Port A output buffers have symmetrical drive characteristics with both high sink and source capability. As inputs, Port A pins that are externally pulled low will source current if the pull-up resistors are activated. The Port A pins are tri-stated when a reset condition becomes active, even if the clock is not running.
Port A also serves the functions of various special features of the Atmel ATmega164A/164PA/324A/324PA/644A/644PA/1284/1284P as listed on page 79.

2.3.4 Port B (PB7:PB0)

Port B is an 8-bit bi-directional I/O port with internal pull-up resistors (selected for each bit). The Port B output buffers have symmetrical drive characteristics with both high sink and source capability. As inputs, Port B pins that are externally pulled low will source current if the pull-up resistors are activated. The Port B pins are tri-stated when a reset condition becomes active, even if the clock is not running.
Port B also serves the functions of various special features of the ATmega164A/164PA/324A/324PA/644A/644PA/1284/1284P as listed on page 80.

2.3.5 Port C (PC7:PC0)

Port C is an 8-bit bi-directional I/O port with internal pull-up resistors (selected for each bit). The Port C output buffers have symmetrical drive characteristics with both high sink and source capability. As inputs, Port C pins that are externally pulled low will source current if the pull-up resistors are activated. The Port C pins are tri-stated when a reset condition becomes active, even if the clock is not running.
Port C also serves the functions of the JTAG interface, along with special features of the Atmel ATmega164A/164PA/324A/324PA/644A/644PA/1284/1284P as listed on page 83.

2.3.6 Port D (PD7:PD0)

Port D is an 8-bit bi-directional I/O port with internal pull-up resistors (selected for each bit). The Port D output buffers have symmetrical drive characteristics with both high sink and source capability. As inputs, Port D pins that are externally pulled low will source current if the pull-up resistors are activated. The Port D pins are tri-stated when a reset condition becomes active, even if the clock is not running.
Port D also serves the functions of various special features of the ATmega164A/164PA/324A/324PA/644A/644PA/1284/1284P as listed on page 86.

2.3.7 $\overline{\text{RESET}}$

Reset input. A low level on this pin for longer than the minimum pulse length will generate a reset, even if the clock is not running. The minimum pulse length is given in "" on page 325. Shorter pulses are not guaranteed to generate a reset.

2.3.8 XTAL1

Input to the inverting Oscillator amplifier and input to the internal clock operating circuit.

2.3.9 XTAL2

Output from the inverting Oscillator amplifier.

2.3.10 AVCC

AVCC is the supply voltage pin for Port A and the Analog-to-digital Converter. It should be externally connected to V_{CC}, even if the ADC is not used. If the ADC is used, it should be connected to V_{CC} through a low-pass filter.

2.3.11 AREF

This is the analog reference pin for the Analog-to-digital Converter.

7. Register summary

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Page
(0xFF)	Reserved	-	-	-	-		-	-	-	
(0xFE)	Reserved	-	-	-	-	-	-	-	-	
(0xFD)	Reserved	-	-	-	-	-	-	-	-	
(0xFC)	Reserved	-	-	-	-	-	-	-	-	
(0xFB)	Reserved	-	-	-	-		-	-	-	
(0xFA)	Reserved	-	-	-	-	-	-	-	-	
(0xF9)	Reserved	-	-	-	-		-	-	-	
(0xF8)	Reserved	-	-	-	-	-	-	-	-	
(0xF7)	Reserved	-	-	-	-	-	-	-	-	
(0xF6)	Reserved	-	-	-	-	-	-	-	-	
(0xF5)	Reserved	-	-	-	-		-	-	-	
(0xF4)	Reserved	-	-	-	-	-	-	-	-	
(0xF3)	Reserved	-	-	-	-	-	-	-	-	
(0xF2)	Reserved	-	-	-	-	-	-	-	-	
(0xF1)	Reserved	-	-	-	-		-	-	-	
(0xF0)	Reserved	-	-	-	-	-	-	-	-	
(0xEF)	Reserved	-	-	-	-		-	-	-	
(0xEE)	Reserved	-	-	-	-	-	-	-	-	
(0xED)	Reserved	-	-	-	-	-	-	-	-	
(0xEC)	Reserved	-	-	-	-	-	-	-	-	
(0xEB)	Reserved	-	-	-	-		-	-	-	
(0xEA)	Reserved	-	-	-	-	-	-	-	-	
(0xE9)	Reserved	-	-	-	-	-	-	-	-	
(0xE8)	Reserved	-	-	-	-	-	-	-	-	
(0xE7)	Reserved	-	-	-	-		-	-	-	
(0xE6)	Reserved	-	-	-	-	-	-	-	-	
(0xE5)	Reserved	-	-	-	-	-	-	-	-	
(0xE4)	Reserved	-	-	-	-	-	-	-	-	
(0xE3)	Reserved	-	-	-	-		-	-	-	
(0xE2)	Reserved	-	-	-	-	-	-	-	-	
(0xE1)	Reserved	-	-	-	-		-	-	-	
(0xE0)	Reserved	-	-	-	-		-	-	-	
(0xDF)	Reserved	-	-	-	-	-	-	-	-	
(0xDE)	Reserved	-	-	-	-	-	-	-	-	
(0xDD)	Reserved	-	-	-	-	-	-	-	-	
(0xDC)	Reserved	-	-	-	-		-	-	-	
(0xDB)	Reserved	-	-	-	-	-	-	-	-	
(0xDA)	Reserved	-	-	-	-	-	-	-	-	
(0xD9)	Reserved	-	-	-	-	-	-	-	-	
(0xD8)	Reserved	-	-	-	-	-	-	-	-	
(0xD7)	Reserved	-	-	-	-	-	-	-	-	
(0xD6)	Reserved	-	-	-	-	-	-	-	-	
(0xD5)	Reserved	-	-	-	-	-	-	-	-	
(0xD4)	Reserved	-	-	-	-	-	-	-	-	
(0xD3)	Reserved	-	-	-	-	-	-	-	-	
(0xD2)	Reserved	-	-	-	-	-	-	-	-	
(0xD1)	Reserved	-	-	-	-	-	-	-	-	
(0xD0)	Reserved	-	-	-	-	-	-	-	-	
(0xCF)	Reserved	-	-	-	-	-	-	-	-	
(0xCE)	UDR1	USART1 I/O Data Register								185
(0xCD)	UBRR1H	-	-	-	-	USART1 Baud Rate Register High Byte				189/202
(0xCC)	UBRR1L	USART1 Baud Rate Register Low Byte								189/202
(0xCB)	Reserved	-	-	-	-	-	-	-	-	
(0xCA)	UCSR1C	UMSEL11	UMSEL10	UPM11	UPM10	USBS1	UCSZ11/UDORD0[5]	UCSZ10/UCPHA0[5]	UCPOL1	187/201
(0xC9)	UCSR1B	RXCIE1	TXCIE1	UDRIE1	RXEN1	TXEN1	UCSZ12	RXB81	TXB81	186/200
(0xC8)	UCSR1A	RXC1	TXC1	UDRE1	FE1	DOR1	UPE1	U2X1	MPCM1	185/200
(0xC7)	Reserved	-	-	-	-	-	-	-	-	
(0xC6)	UDR0	USART0 I/O Data Register								185
(0xC5)	UBRR0H	-	-	-	-	USART0 Baud Rate Register High Byte				189/202
(0xC4)	UBRR0L	USART0 Baud Rate Register Low Byte								189/202
(0xC3)	Reserved	-	-	-	-	-	-	-	-	
(0xC2)	UCSR0C	UMSEL01	UMSEL00	UPM01	UPM00	USBS0	UCSZ01/UDORD0[5]	UCSZ00/UCPHA0[5]	UCPOL0	187/201
(0xC1)	UCSR0B	RXCIE0	TXCIE0	UDRIE0	RXEN0	TXEN0	UCSZ02	RXB80	TXB80	186/200

8. Instruction set summary

Mnemonics	Operands	Description	Operation	Flags	#Clocks
ARITHMETIC AND LOGIC INSTRUCTIONS					
ADD	Rd, Rr	Add two Registers	Rd ← Rd + Rr	Z,C,N,V,H	1
ADC	Rd, Rr	Add with Carry two Registers	Rd ← Rd + Rr + C	Z,C,N,V,H	1
ADIW	Rdl,K	Add Immediate to Word	Rdh:Rdl ← Rdh:Rdl + K	Z,C,N,V,S	2
SUB	Rd, Rr	Subtract two Registers	Rd ← Rd - Rr	Z,C,N,V,H	1
SUBI	Rd, K	Subtract Constant from Register	Rd ← Rd - K	Z,C,N,V,H	1
SBC	Rd, Rr	Subtract with Carry two Registers	Rd ← Rd - Rr - C	Z,C,N,V,H	1
SBCI	Rd, K	Subtract with Carry Constant from Reg.	Rd ← Rd - K - C	Z,C,N,V,H	1
SBIW	Rdl,K	Subtract Immediate from Word	Rdh:Rdl ← Rdh:Rdl - K	Z,C,N,V,S	2
AND	Rd, Rr	Logical AND Registers	Rd ← Rd • Rr	Z,N,V	1
ANDI	Rd, K	Logical AND Register and Constant	Rd ← Rd • K	Z,N,V	1
OR	Rd, Rr	Logical OR Registers	Rd ← Rd v Rr	Z,N,V	1
ORI	Rd, K	Logical OR Register and Constant	Rd ← Rd v K	Z,N,V	1
EOR	Rd, Rr	Exclusive OR Registers	Rd ← Rd ⊕ Rr	Z,N,V	1
COM	Rd	One's Complement	Rd ← 0xFF – Rd	Z,C,N,V	1
NEG	Rd	Two's Complement	Rd ← 0x00 – Rd	Z,C,N,V,H	1
SBR	Rd,K	Set Bit(s) in Register	Rd ← Rd v K	Z,N,V	1
CBR	Rd,K	Clear Bit(s) in Register	Rd ← Rd • (0xFF - K)	Z,N,V	1
INC	Rd	Increment	Rd ← Rd + 1	Z,N,V	1
DEC	Rd	Decrement	Rd ← Rd – 1	Z,N,V	1
TST	Rd	Test for Zero or Minus	Rd ← Rd • Rd	Z,N,V	1
CLR	Rd	Clear Register	Rd ← Rd ⊕ Rd	Z,N,V	1
SER	Rd	Set Register	Rd ← 0xFF	None	1
MUL	Rd, Rr	Multiply Unsigned	R1:R0 ← Rd x Rr	Z,C	2
MULS	Rd, Rr	Multiply Signed	R1:R0 ← Rd x Rr	Z,C	2
MULSU	Rd, Rr	Multiply Signed with Unsigned	R1:R0 ← Rd x Rr	Z,C	2
FMUL	Rd, Rr	Fractional Multiply Unsigned	R1:R0 ← (Rd x Rr) << 1	Z,C	2
FMULS	Rd, Rr	Fractional Multiply Signed	R1:R0 ← (Rd x Rr) << 1	Z,C	2
FMULSU	Rd, Rr	Fractional Multiply Signed with Unsigned	R1:R0 ← (Rd x Rr) << 1	Z,C	2
BRANCH INSTRUCTIONS					
RJMP	k	Relative Jump	PC ← PC + k + 1	None	2
IJMP		Indirect Jump to (Z)	PC ← Z	None	2
JMP	k	Direct Jump	PC ← k	None	3
RCALL	k	Relative Subroutine Call	PC ← PC + k + 1	None	3
ICALL		Indirect Call to (Z)	PC ← Z	None	3
CALL	k	Direct Subroutine Call	PC ← k	None	4
RET		Subroutine Return	PC ← STACK	None	4
RETI		Interrupt Return	PC ← STACK	I	4
CPSE	Rd,Rr	Compare, Skip if Equal	if (Rd = Rr) PC ← PC + 2 or 3	None	1/2/3
CP	Rd,Rr	Compare	Rd – Rr	Z, N,V,C,H	1
CPC	Rd,Rr	Compare with Carry	Rd – Rr – C	Z, N,V,C,H	1
CPI	Rd,K	Compare Register with Immediate	Rd – K	Z, N,V,C,H	1
SBRC	Rr, b	Skip if Bit in Register Cleared	if (Rr(b)=0) PC ← PC + 2 or 3	None	1/2/3
SBRS	Rr, b	Skip if Bit in Register is Set	if (Rr(b)=1) PC ← PC + 2 or 3	None	1/2/3
SBIC	P, b	Skip if Bit in I/O Register Cleared	if (P(b)=0) PC ← PC + 2 or 3	None	1/2/3
SBIS	P, b	Skip if Bit in I/O Register is Set	if (P(b)=1) PC ← PC + 2 or 3	None	1/2/3
BRBS	s, k	Branch if Status Flag Set	if (SREG(s) = 1) then PC←PC+k + 1	None	1/2
BRBC	s, k	Branch if Status Flag Cleared	if (SREG(s) = 0) then PC←PC+k + 1	None	1/2
BREQ	k	Branch if Equal	if (Z = 1) then PC ← PC + k + 1	None	1/2
BRNE	k	Branch if Not Equal	if (Z = 0) then PC ← PC + k + 1	None	1/2
BRCS	k	Branch if Carry Set	if (C = 1) then PC ← PC + k + 1	None	1/2
BRCC	k	Branch if Carry Cleared	if (C = 0) then PC ← PC + k + 1	None	1/2
BRSH	k	Branch if Same or Higher	if (C = 0) then PC ← PC + k + 1	None	1/2
BRLO	k	Branch if Lower	if (C = 1) then PC ← PC + k + 1	None	1/2
BRMI	k	Branch if Minus	if (N = 1) then PC ← PC + k + 1	None	1/2
BRPL	k	Branch if Plus	if (N = 0) then PC ← PC + k + 1	None	1/2
BRGE	k	Branch if Greater or Equal, Signed	if (N ⊕ V= 0) then PC ← PC + k + 1	None	1/2
BRLT	k	Branch if Less Than Zero, Signed	if (N ⊕ V= 1) then PC ← PC + k + 1	None	1/2
BRHS	k	Branch if Half Carry Flag Set	if (H = 1) then PC ← PC + k + 1	None	1/2
BRHC	k	Branch if Half Carry Flag Cleared	if (H = 0) then PC ← PC + k + 1	None	1/2
BRTS	k	Branch if T Flag Set	if (T = 1) then PC ← PC + k + 1	None	1/2
BRTC	k	Branch if T Flag Cleared	if (T = 0) then PC ← PC + k + 1	None	1/2
BRVS	k	Branch if Overflow Flag is Set	if (V = 1) then PC ← PC + k + 1	None	1/2

Mnemonics	Operands	Description	Operation	Flags	#Clocks
MCU CONTROL INSTRUCTIONS					
NOP		No Operation		None	1
SLEEP		Sleep	(see specific descr. for Sleep function)	None	1
WDR		Watchdog Reset	(see specific descr. for WDR/timer)	None	1
BREAK		Break	For On-chip Debug Only	None	N/A

9.2 Atmel ATmega164PA

Speed [MHz] (3)	Power supply	Ordering code (2)	Package (1)	Operational range
20	1.8 - 5.5V	ATmega164PA-AU ATmega164PA-AUR(5) ATmega164PA-PU ATmega164PA-MU ATmega164PA-MUR(5) ATmega164PA-MCH(4) ATmega164PA-MCHR(4)(5) ATmega164PA-CU ATmega164PA-CUR(5)	44A 44A 40P6 44M1 44M1 44MC 44MC 49C2 49C2	Industrial (-40°C to 85°C)
20	1.8 - 5.5V	ATmega164PA-AN ATmega164PA-ANR(5) ATmega164PA-PN ATmega164PA-MN ATmega164PA-MNR(5)	44A 44A 40P6 44M1 44M1	Industrial (-40°C to 105°C)

Notes:
1. This device can also be supplied in wafer form. Please contact your local Atmel sales office for detailed ordering information and minimum quantities.
2. Pb-free packaging, complies to the European Directive for Restriction of Hazardous Substances (RoHS directive). Also Halide free and fully Green.
3. For Speed vs. V_{CC} see ”Speed grades” on page 324.
4. NiPdAu Lead Finish.
5. Tape & Reel.

Package Type	
44A	44-lead, Thin (1.0mm) Plastic Gull Wing Quad Flat Package (TQFP)
40P6	40-pin, 0.600” Wide, Plastic Dual Inline Package (PDIP)
44M1	44-pad, 7 × 7 × 1.0mm body, lead pitch 0.50mm, Thermally Enhanced Plastic Very Thin Quad Flat No-Lead (VQFN)
44MC	44-lead (2-row Staggered), 5 × 5 × 1.0mm body, 2.60 × 2.60mm Exposed Pad, Quad Flat No-Lead Package (QFN)
49C2	49-ball, (7 × 7 Array) 0.65mm Pitch, 5 × 5 × 1mm, Very Thin, Fine-Pitch Ball Grid Array Package (VFBGA)

9.3 Atmel ATmega324A

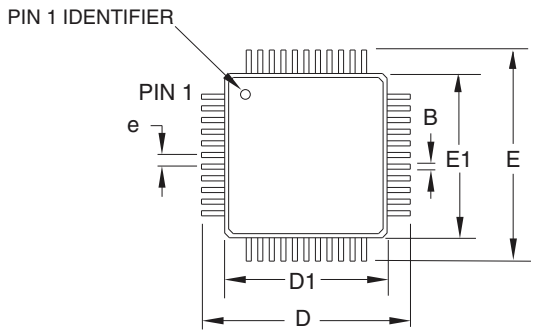
Speed [MHz] (3)	Power supply	Ordering code (2)	Package (1)	Operational range
20	1.8 - 5.5V	ATmega324A-AU ATmega324A-AUR(5) ATmega324A-PU ATmega324A-MU ATmega324A-MUR(5) ATmega324A-MCH(4) ATmega324A-MCHR(4)(5) ATmega324A-CU ATmega324A-CUR(5)	44A 44A 40P6 44M1 44M1 44MC 44MC 49C2 49C2	Industrial (-40°C to 85°C)

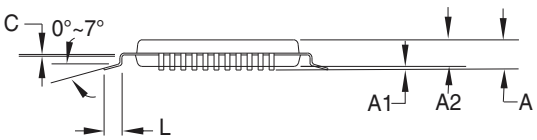
Notes:
1. This device can also be supplied in wafer form. Please contact your local Atmel sales office for detailed ordering information and minimum quantities.
2. Pb-free packaging, complies to the European Directive for Restriction of Hazardous Substances (RoHS directive). Also Halide free and fully Green.
3. For Speed vs. V_{CC} see ”Speed grades” on page 324.
4. NiPdAu Lead Finish.
5. Tape & Reel.

Package Type	
44A	44-lead, Thin (1.0mm) Plastic Gull Wing Quad Flat Package (TQFP)
40P6	40-pin, 0.600” Wide, Plastic Dual Inline Package (PDIP)
44M1	44-pad, 7 × 7 × 1.0mm body, lead pitch 0.50mm, Thermally Enhanced Plastic Very Thin Quad Flat No-Lead (VQFN)
44MC	44-lead (2-row Staggered), 5 × 5 × 1.0mm body, 2.60 × 2.60mm Exposed Pad, Quad Flat No-Lead Package (QFN)
49C2	49-ball, (7 × 7 Array) 0.65mm Pitch, 5 × 5 × 1mm, Very Thin, Fine-Pitch Ball Grid Array Package (VFBGA)

10. Packaging information

10.1 44A





COMMON DIMENSIONS
(Unit of Measure = mm)

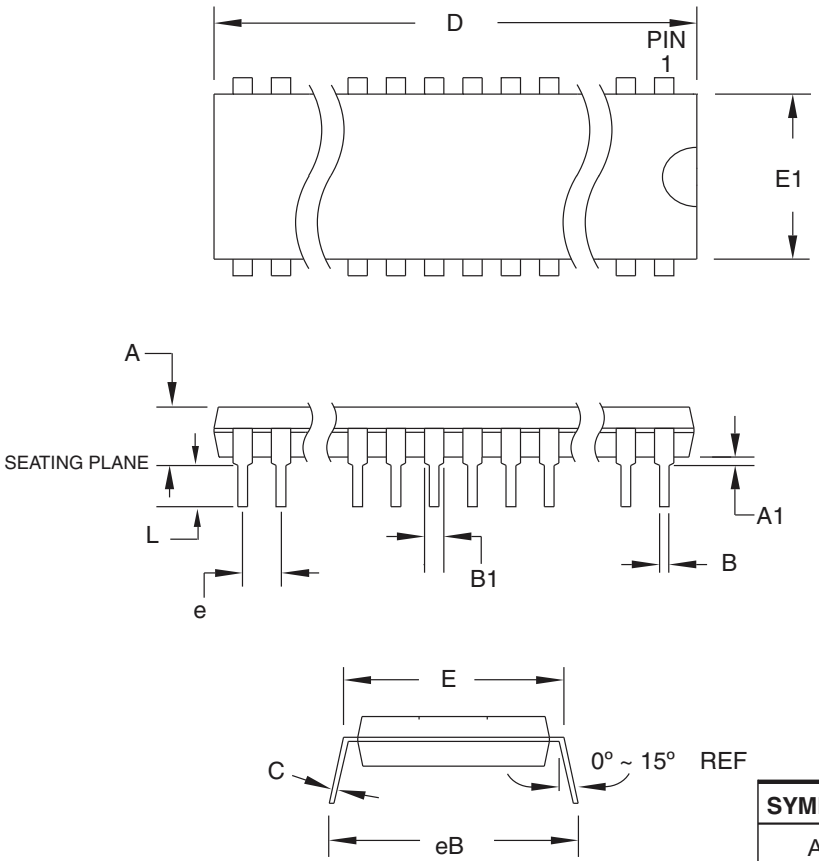
SYMBOL	MIN	NOM	MAX	NOTE
A	–	–	1.20	
A1	0.05	–	0.15	
A2	0.95	1.00	1.05	
D	11.75	12.00	12.25	
D1	9.90	10.00	10.10	Note 2
E	11.75	12.00	12.25	
E1	9.90	10.00	10.10	Note 2
B	0.30	0.37	0.45	
C	0.09	(0.17)	0.20	
L	0.45	0.60	0.75	
e	0.80 TYP			

Notes:
1. This package conforms to JEDEC reference MS-026, Variation ACB.
2. Dimensions D1 and E1 do not include mold protrusion. Allowable protrusion is 0.25mm per side. Dimensions D1 and E1 are maximum plastic body size dimensions including mold mismatch.
3. Lead coplanarity is 0.10mm maximum.

06/02/2014

Atmel Package Drawing Contact: packagedrawings@atmel.com	TITLE	DRAWING NO.	REV.
	44A, 44-lead, 10 x 10mm body size, 1.0mm body thickness, 0.8 mm lead pitch, thin profile plastic quad flat package (TQFP)	44A	C

10.2 40P6



COMMON DIMENSIONS
(Unit of Measure = mm)

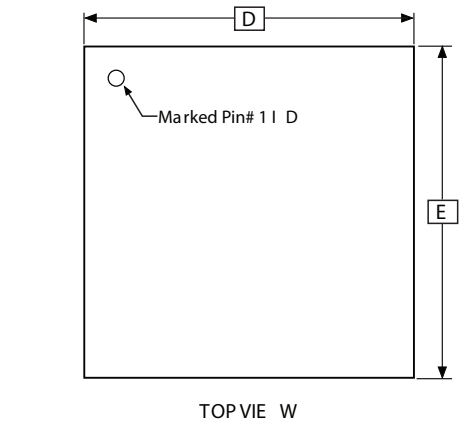
SYMBOL	MIN	NOM	MAX	NOTE
A	–	–	4.826	
A1	0.381	–	–	
D	52.070	–	52.578	Note 2
E	15.240	–	15.875	
E1	13.462	–	13.970	Note 2
B	0.356	–	0.559	
B1	1.041	–	1.651	
L	3.048	–	3.556	
C	0.203	–	0.381	
eB	15.494	–	17.526	
e	2.540 TYP			

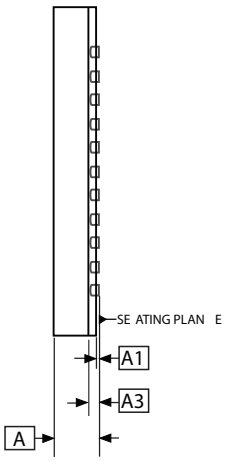
Notes:
1. This package conforms to JEDEC reference MS-011, Variation AC.
2. Dimensions D and E1 do not include mold Flash or Protrusion. Mold Flash or Protrusion shall not exceed 0.25mm (0.010").

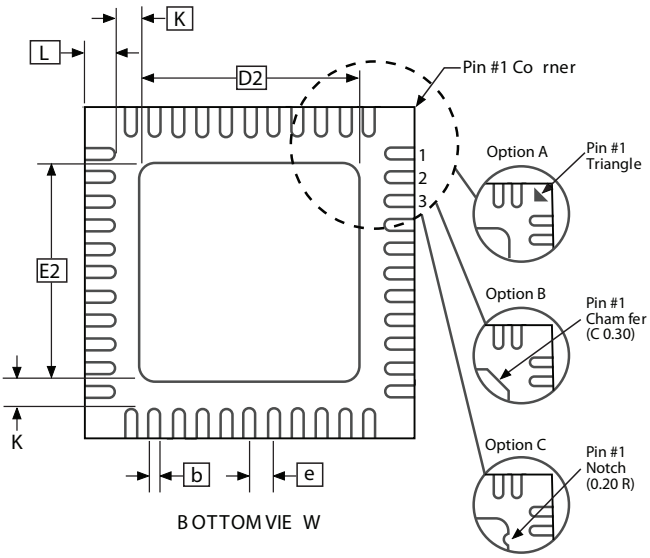
13/02/2014

Atmel Package Drawing Contact: packagedrawings@atmel.com	TITLE	DRAWING NO.	REV.
	40P6, 40-lead (0.600"/15.24mm Wide) Plastic Dual Inline Package (PDIP)	40P6	C

10.3 44M1







Note: JEDEC Standard MO-220, Fig . 1 (S AW Singulation) VKKD-3 .

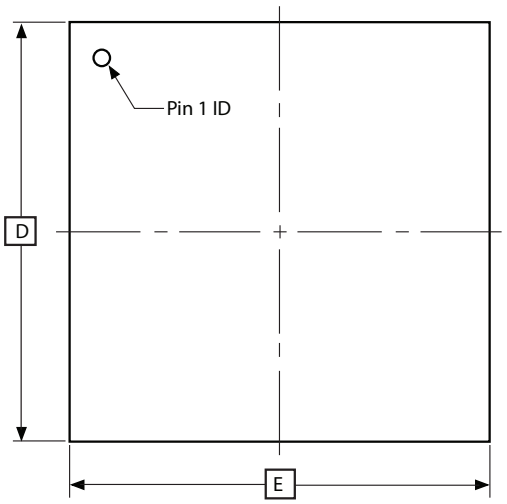
COMMON DIMENSIONS
(Unit of Measure = mm)

SYMBOL	MIN	NOM	MAX	NOTE
A	0.80	0.90	1.00	
A1	–	0.02	0.05	
A3		0.20 REF		
b	0.18	0.23	0.30	
D	6.90	7.00	7.10	
D2	5.00	5.20	5.40	
E	6.90	7.00	7.10	
E2	5.00	5.20	5.40	
e		0.50 BSC		
L	0.59	0.64	0.69	
K	0.20	0.26	0.41	

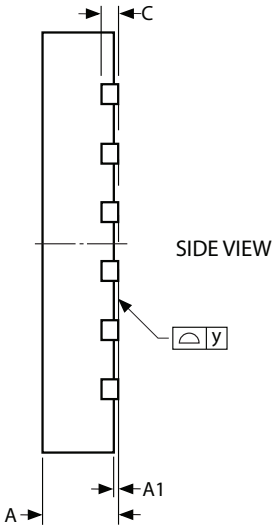
9/26/08

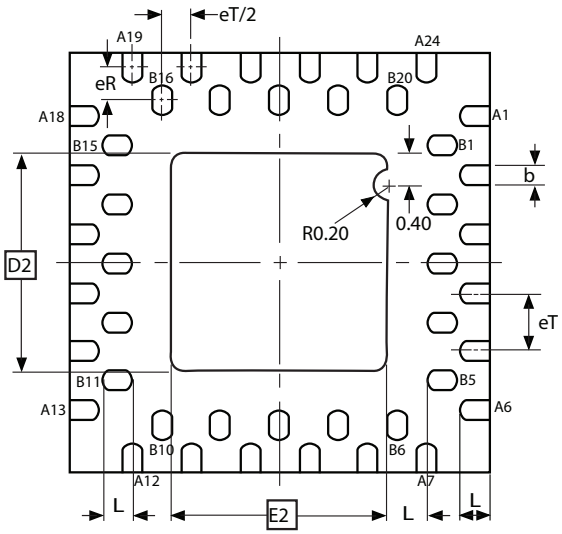
Atmel Package Drawing Contact: avr@atmel.com	TITLE 44M1, 44-pad, 7 x 7 x 1.0mm body, lead pitch 0.50mm, 5.20mm exposed pad, thermally enhanced plastic very thin quad flat no lead package (VQFN)	GPC ZWS	DRAWING NO. 44M1	REV. H

10.4 44MC



TOP VIEW





BOTTOM VIEW

COMMON DIMENSIONS
(Unit of Measure = mm)

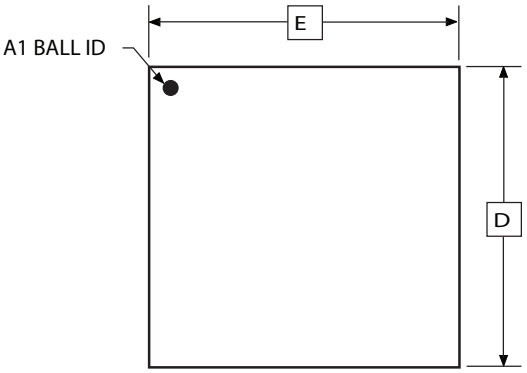
SYMBOL	MIN	NOM	MAX	NOTE
A	0.80	0.90	1.00	
A1	0.00	0.02	0.05	
b	0.18	0.23	0.30	
C		0.20 REF		
D	4.90	5.00	5.10	
D2	2.55	2.60	2.65	
E	4.90	5.00	5.10	
E2	2.55	2.60	2.65	
eT	–	0.70	–	
eR	–	0.40	–	
K	0.45	–	–	
L	0.30	0.35	0.40	
y	0.00	–	0.075	

Note: 1. The terminal #1 ID is a Laser-marked Feature.

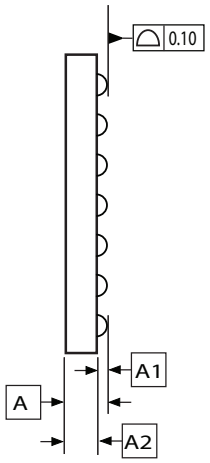
9/13/07

Atmel	Package Drawing Contact: packagedrawings@atmel.com	TITLE 44MC, 44QFN (2-Row Staggered), 5 x 5 x 1.00 mm Body, 2.60 x 2.60 mm Exposed Pad, Quad Flat No Lead Package	DRA WING NO . 44MC	REV . A

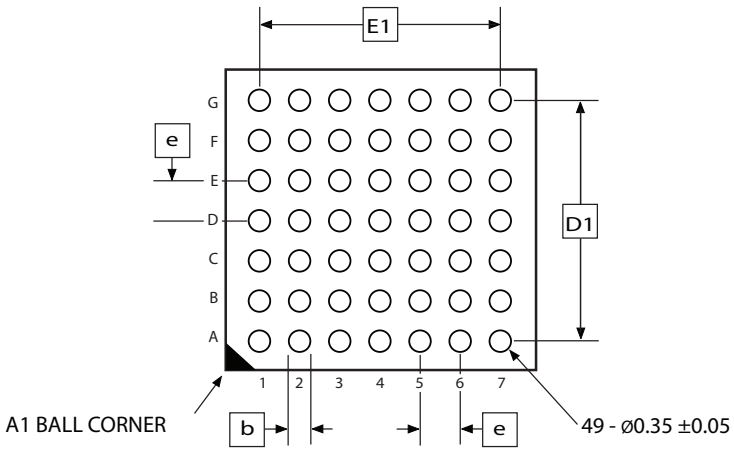
10.5 49C2



TOP VIEW



SIDE VIEW



BOTTOM VIEW

COMMON DIMENSIONS
(Unit of Measure = mm)

SYMBOL	MIN	NOM	MAX	NOTE
A	–	–	1.00	
A1	0.20	–	–	
A2	0.65	–	–	
D	4.90	5.00	5.10	
D1		3.90 BSC		
E4.90	5.00	5.10		
E1		3.90 BSC		
b	0.30	0.35	0.40	
e		0.65 BSC		

3/14/08

Atmel Package Drawing Contact: packagedrawings@atmel.com	TITLE 49C2, 49-ball (7 x 7 array), 0.65mm pitch, 5.0 x 5.0 x 1.0mm, very thin, fine-pitch ball grid array package (VFBGA)	GPC CBD	DRAWING NO. 49C2	REV. A

11. Errata

11.1 Errata for ATmega164A

11.1.1 Rev. E

No known Errata.

11.2 Errata for ATmega164PA

11.2.1 Rev. E

No known Errata.

11.3 Errata for ATmega324A

11.3.1 Rev. F

No known Errata.

11.4 Errata for ATmega324PA

11.4.1 Rev. F

No known Errata.

11.5 Errata for ATmega644A

11.5.1 Rev. F

No known Errata.

11.6 Errata for ATmega644PA

11.6.1 Rev. F

No known Errata.

11.7 Errata for ATmega1284

11.7.1 Rev. B

No known Errata.

11.8 Errata for ATmega1284P

11.8.1 Rev. B

No known Errata.

12.3 Rev. 8272E - 04/2013

1.	Updated Figure 1-1 on page 3 and Figure 2-1 on page 6: T3 and T/C3 only available in ATmega1284/1284P.
2.	Updated descriptive text on page 6 to indicate that ATmega1284/1284P has four T/Cs.
3.	Updated the Assembly code example for WDT_off (p.56) following the ej# 705736.
4.	Added note in ”16-bit Timer/Counter1 and Timer/Counter3(1) with PWM” on page 107.
5.	Added ”Prescaler Reset” on page 112.
6.	Corrected three typo for Waveform generation mode (WGM) instead of MGM.
7.	Updated Table 23-6 on page 253. ADC Auto Trigger Source Selections, ADTS=0b011, the statement is Timer/Counter0 Compare Match A.
8.	Updated Table 27-18 on page 310. Command for 6d Poll for Fuse Write Complete: 0111011_00000000
9.	Updated the table notes of the Table 28-1 on page 318.
10.	Updated ”Register summary” on page 10. Added table note 7: Only available in ATmega1284/1284P.

12.4 Rev. 8272D - 05/12

1.	Updated ”Power-down mode” on page 44.
2.	Updated ”Overview” on page 67.
3.	Corrected references for Bit 2, Bit 1, and Bit 0 in Section ”UCSRnC – USART MSPIM Control and Status Register n C” on page 201.
4.	Several small corrections throughout the whole document made according to the template
5.	Notes in Table 27-17 on page 304 have been corrected
6.	Note (1) in Table 28-3 on page 320 is added

12.5 Rev. 8272C - 06/11

1.	Updated ”Atmel ATmega1284P DC characteristics” on page 323.

12.6 Rev. 8272B - 05/11

1.	Added Atmel QTouch Library Support and QTouch Sensing Capability Features.
2.	Replaced the Figure 1-1 on page 3 by an updated “Pinout.” that includes Timer/Counter3.
3.	Replaced the Figure 7-1 on page 10 by an updated “Block diagram of the AVR architecture.” that includes Timer/Counter3.
4.	Added ”RAMPZ – Extended Z-pointer Register for ELPM/SPM(1)” on page 15.
5.	Added ”PRR1 – Power Reduction Register 1” on page 49.
6.	Renamed PRR to ”PRR0 – Power Reduction Register 0” on page 48.
7.	Updated ”PCIFR – Pin Change Interrupt Flag Register” on page 69. PCICR replaces EIMSR in the PCIF3, PCIF2, PCIF1 and PCIF0 bit description.
8.	Updated ”PCMSK3 – Pin Change Mask Register 3” on page 70. PCIE3 replaces PCIE2 in the bit description.
9.	Updated ”Alternate Functions of Port B” on page 80 to include Timer/Counter3
10.	Updated ”Alternate Functions of Port D” on page 86 to include Timer/Counter3
11.	Added ”TCNT3H and TCNT3L –Timer/Counter3” on page 132

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